

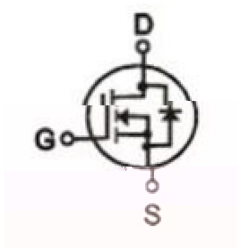
/ Descriptions

x

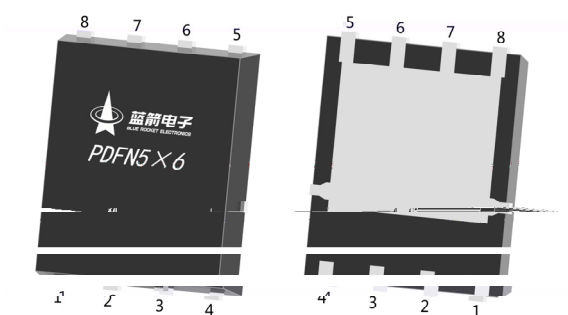
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D

/ Marking

/ Electrical Characteristics(Ta=25)

		Ω Ω				

/ Electrical Characteristic Curve

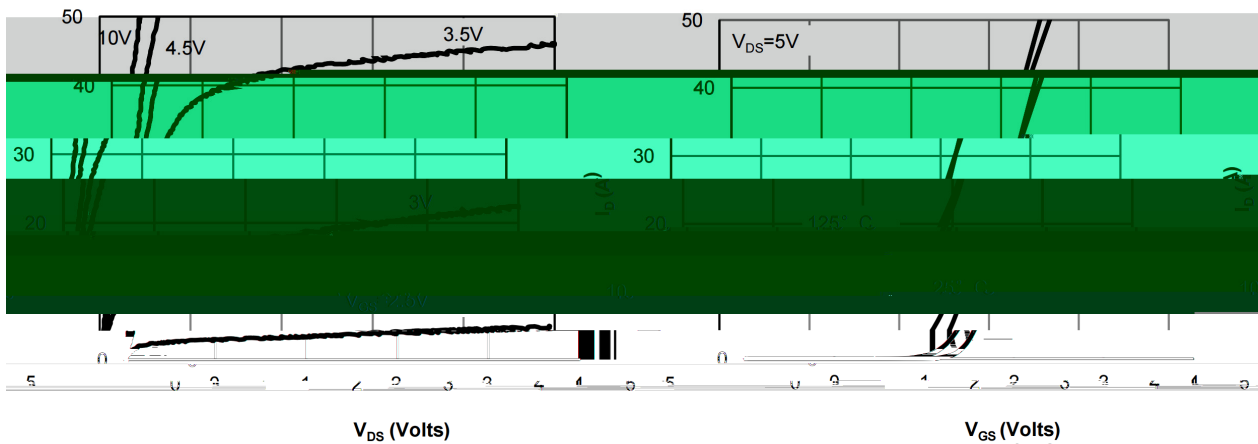
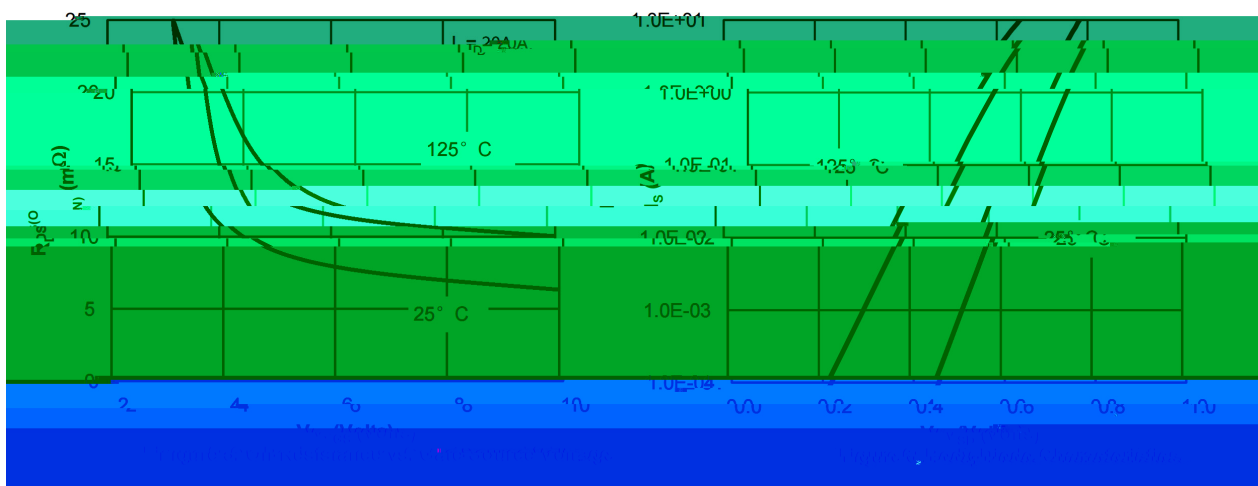
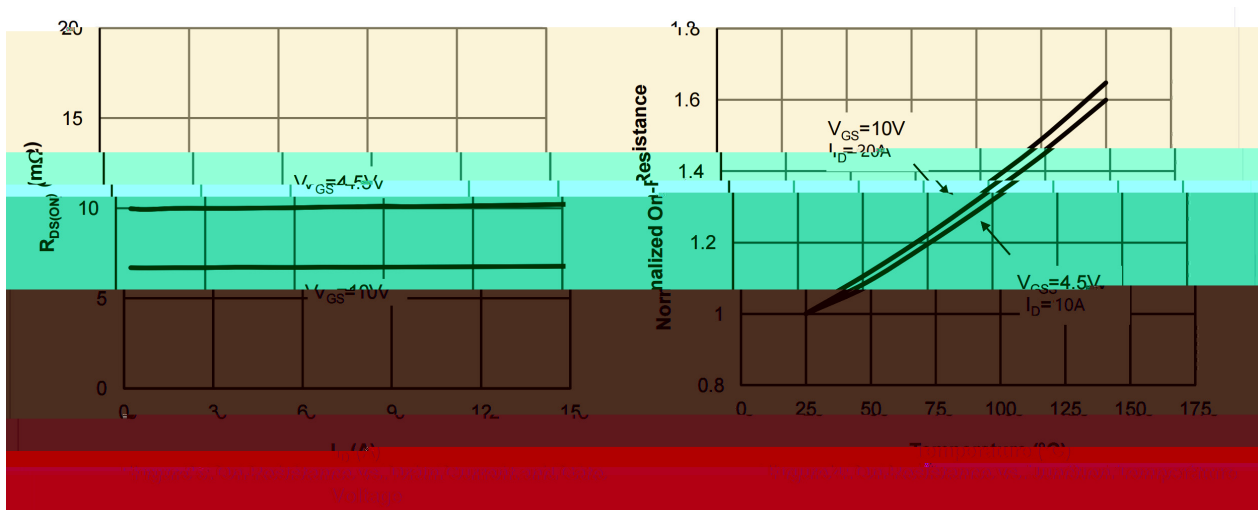


Figure 1 Drain Current Characteristics

Figure 2 Transfer Characteristics



/ Electrical Characteristic Curve

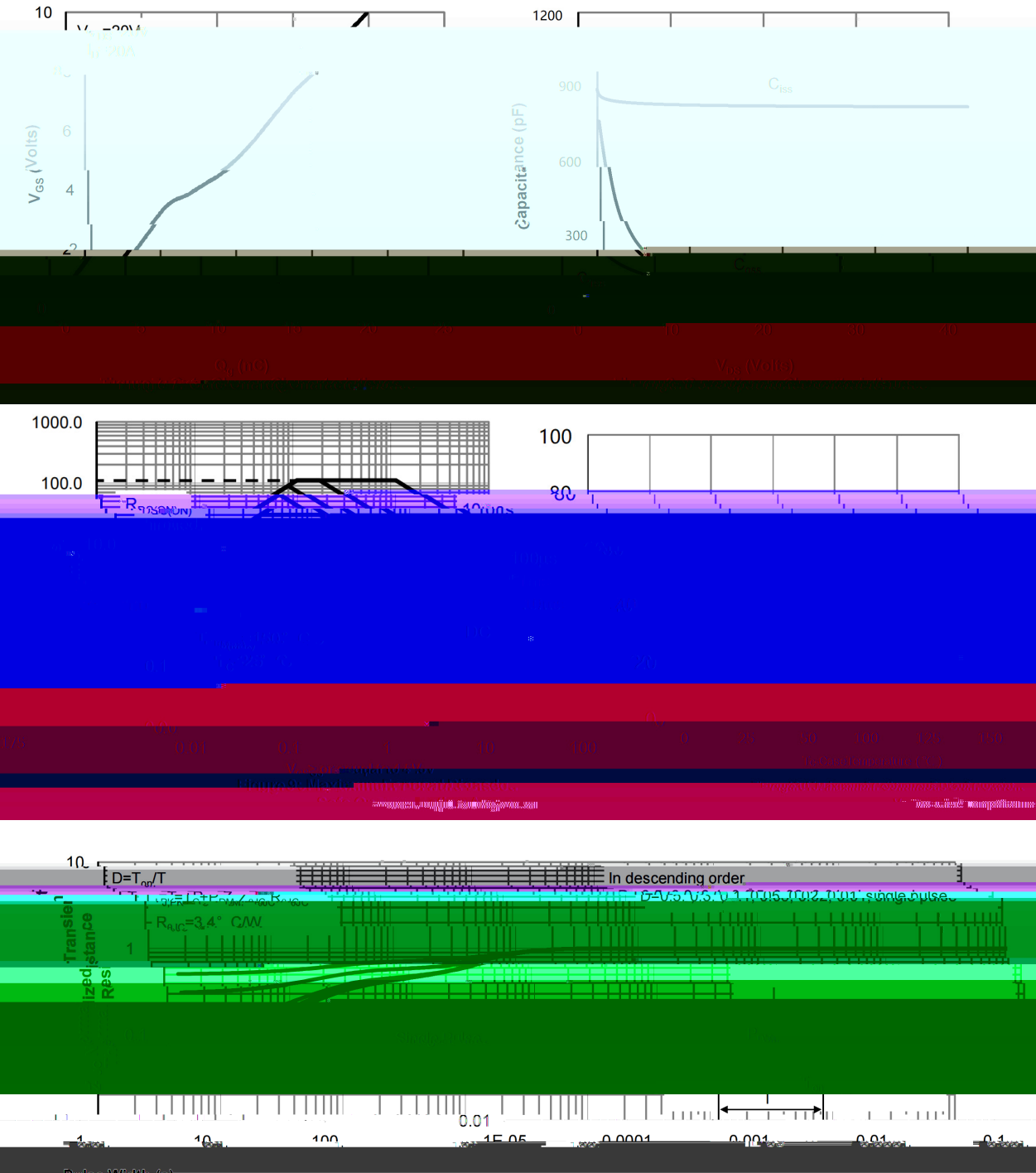
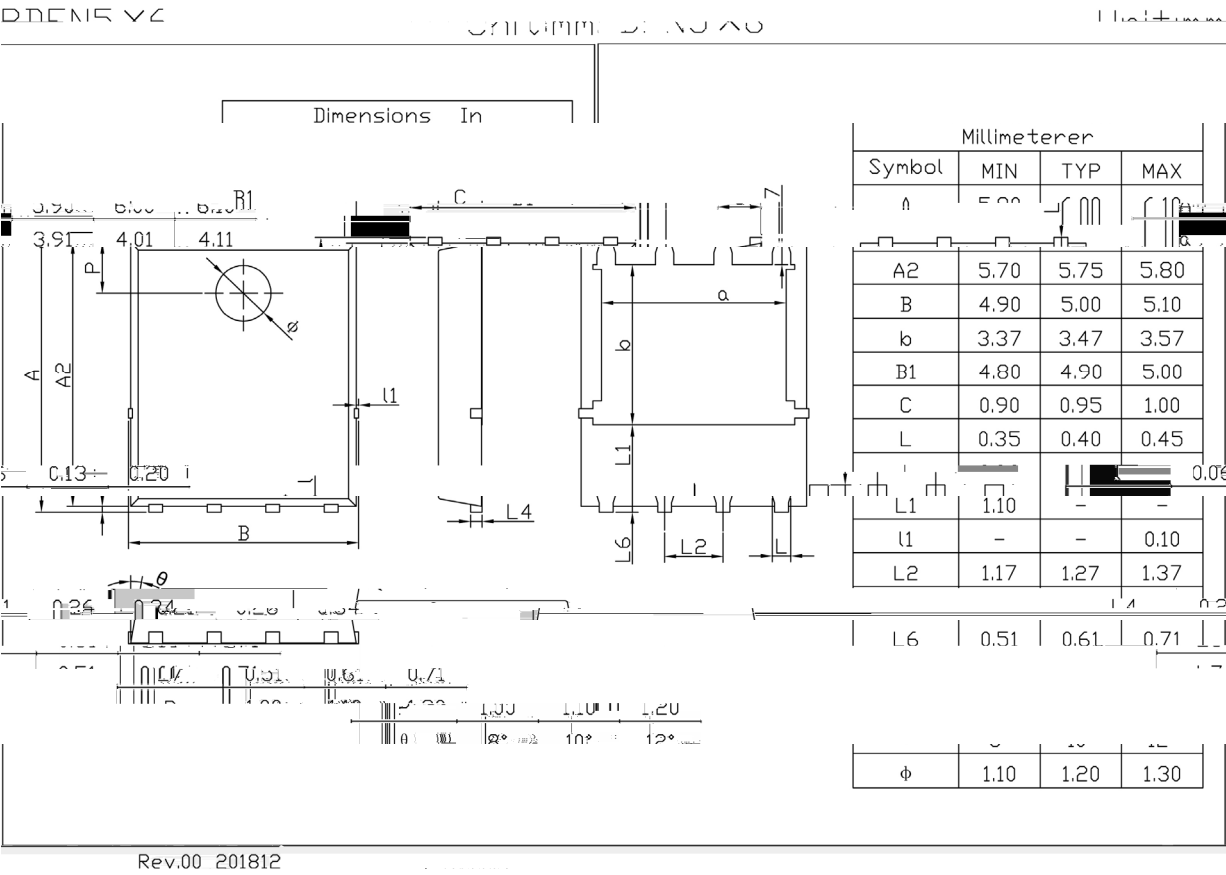
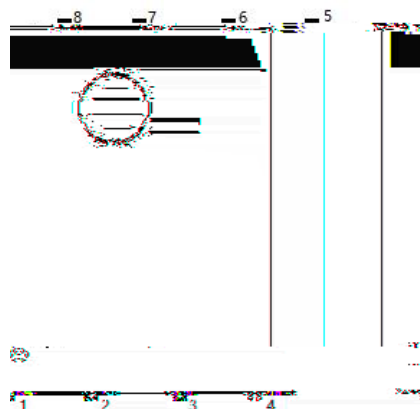


Figure 11: Normalized Maximum Transient Thermal Impedance

/ Package Dimensions



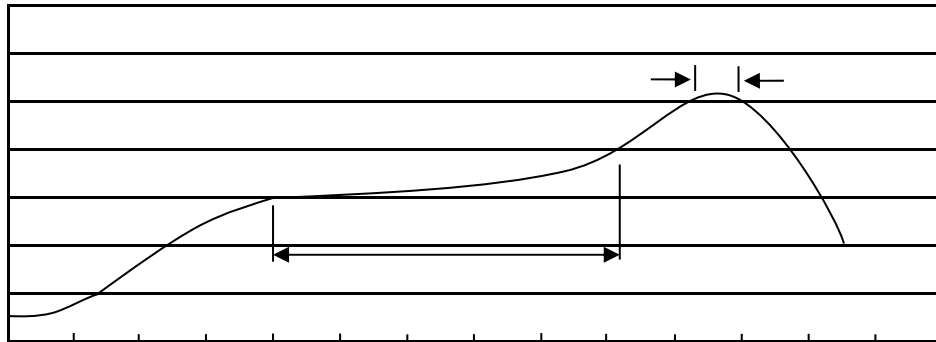
/ Marking Instructions



BR

Q

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

 $\pm$ $\pm$ $\pm$ $\pm$

/ Resistance to Soldering Heat Test Conditions

 $\pm$ $\pm$ $\pm$ $\pm$

/ Packaging SPEC.

	/	/	/	/	/		x x	x x
x						x	x x	x x

/ Notices